

# High Precision Tracking based on CMOS Pixel Sensors

M. Winter (PICSEL team of IPHC-Strasbourg)

Partnership between IPHC-Strasbourg & IHEP-Beijing

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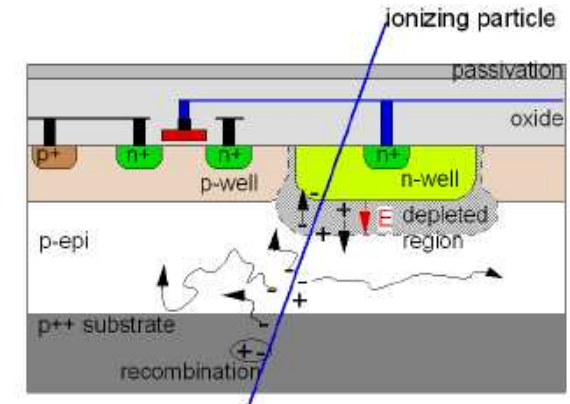
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- *Basic features of CMOS sensors :*
  - ✧ general remarks on highly pixelated and thin sensors
  - ✧ generic aspects of existing MIMOSA sensors
- *Project topic :*
  - ✧ BESIII Main Drift Chamber characteristics
  - ✧ Potential added-value of CMOS pixel sensors to cope with lumi increase
  - ✧ Development actions: CMOS sensors, ultra-light ladders
- *Summary*

# CMOS Pixel Sensors: State of the Art

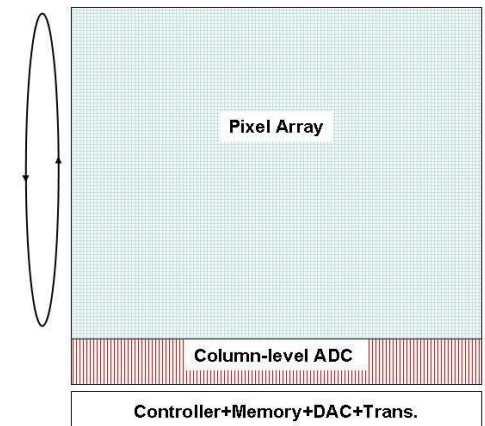
- **Prominent features of CMOS pixel sensors:**

- ✧ high granularity  $\Rightarrow$  excellent (micronic) spatial resolution
- ✧ very thin (signal generated in 10-20  $\mu m$  thin epitaxial layer)
- ✧ signal processing  $\mu$ -circuits integrated on sensor substrate  
 $\Rightarrow$  impact on downstream electronics ( $\Rightarrow$  cost)



- **Organisation of MIMOSA sensors:**

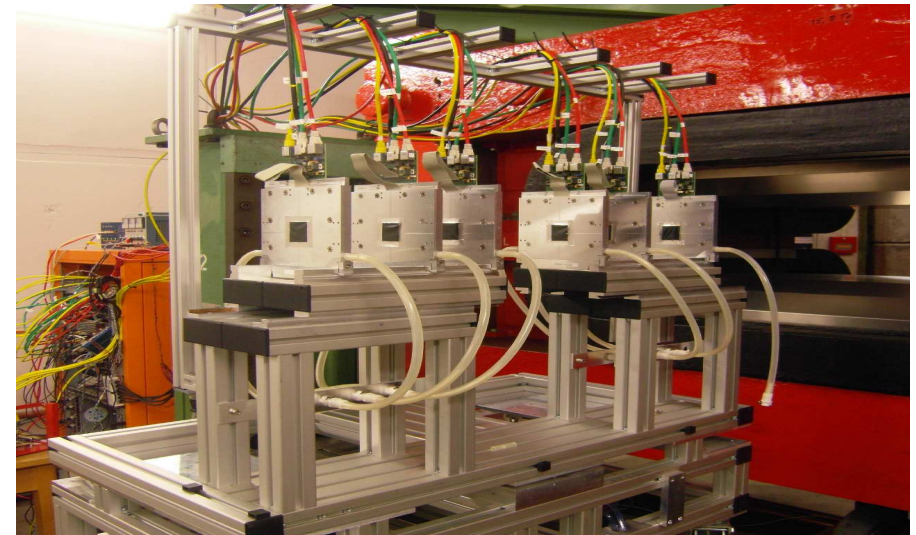
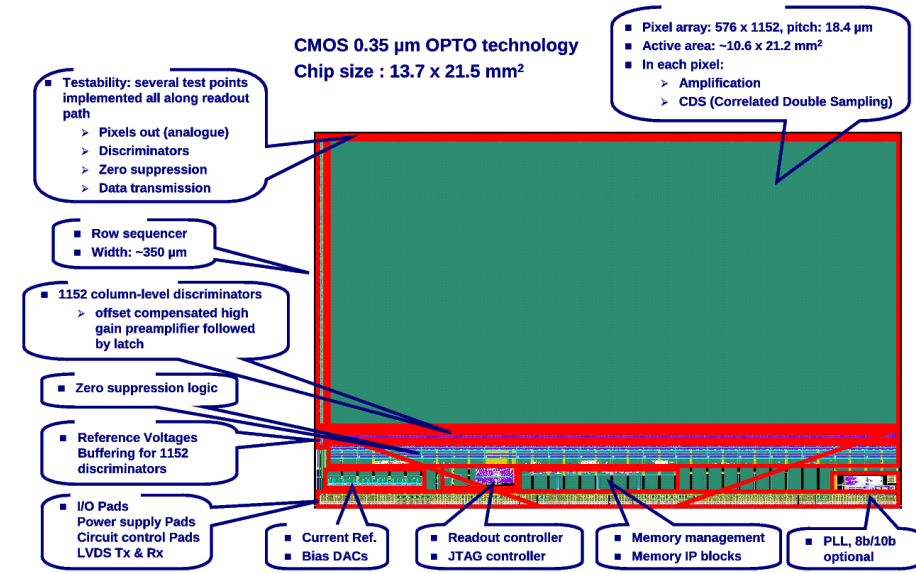
- ✧ manufactured in 0.35  $\mu m$  OPTO process
- ✧ signal sensing and analog processing in pixel array
- ✧ mixed and digital circuitry integrated in chip periphery
- ✧ read-out in rolling shutter mode  
(pixels grouped in columns read out in //)  
 $\Rightarrow$  impact on power consumption



# CMOS Pixel Sensors: Established Architecture

- Main characteristics of MIMOSA sensor equipping EUDET BT:

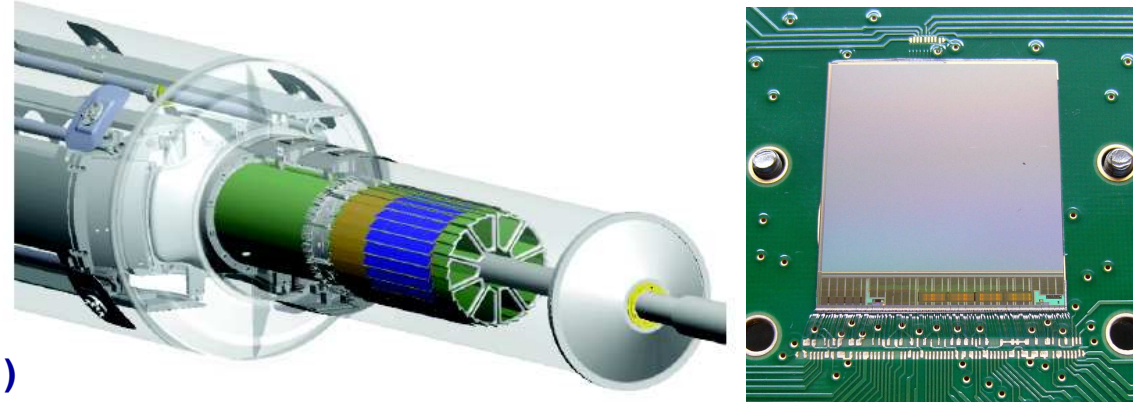
- ✧  $0.35 \mu m$  process with high-resistivity epitaxial layer  
(coll. with IRFU/Saclay)
- ✧ column // architecture with in-pixel amplification (cDS)  
and end-of-column discrimination, followed by  $\emptyset$
- ✧ binary charge encoding
- ✧ active area: 1152 columns of 576 pixels ( $21.2 \times 10.6 \text{ mm}^2$ )
- ✧ pitch:  $18.4 \mu m \rightarrow \sim 0.7$  million pixels
  - ▷ charge sharing  $\Rightarrow \sigma_{sp} \sim 3\text{-}3.5 \mu m$
- ✧  $t_{r.o.} \lesssim 100 \mu s$  ( $\sim 10^4$  frames/s)  
suited to  $> 10^6 \text{ part./cm}^2/\text{s}$
- ✧ JTAG programmable
- ✧ rolling shutter architecture
  - $\Rightarrow$  full sensitive area dissipation  $\cong 1$  row
    - ▷  $\sim 250 \text{ mW/cm}^2$  power consumption (fct of  $N_{col}$ )
- ✧ thinned to  $50 \mu m$
- ✧ various appli. : VD demonstr., NA63, oncotherapy, dosimetry, ...



# State-of-the-Art: MIMOSA-28 for the STAR-PXL

## ● Main characteristics of ULTIMATE ( $\equiv$ MIMOSA-28):

- \* 0.35  $\mu m$  process with high-resistivity epitaxial layer
- \* column // architecture with in-pixel cDS & amplification
- \* end-of-column discrimination & binary charge encoding
- \* on-chip zero-suppression
- \* **active area: 960 columns of 928 pixels ( $19.9 \times 19.2 \text{ mm}^2$ )**
- \* **pitch: 20.7  $\mu m \rightarrow \sim 0.9$  million pixels**
  - $\hookrightarrow$  **charge sharing  $\Rightarrow \sigma_{sp} \gtrsim 3.5 \mu m$**
- \* JTAG programmable
- \*  **$t_{r.o.} \lesssim 200 \mu s$  ( $\sim 5 \times 10^3$  frames/s)  $\Rightarrow$  suited to  $> 10^6$  part./cm<sup>2</sup>/s**
- \* 2 outputs at 160 MHz
- \*  $\lesssim 150 \text{ mW/cm}^2$  power consumption

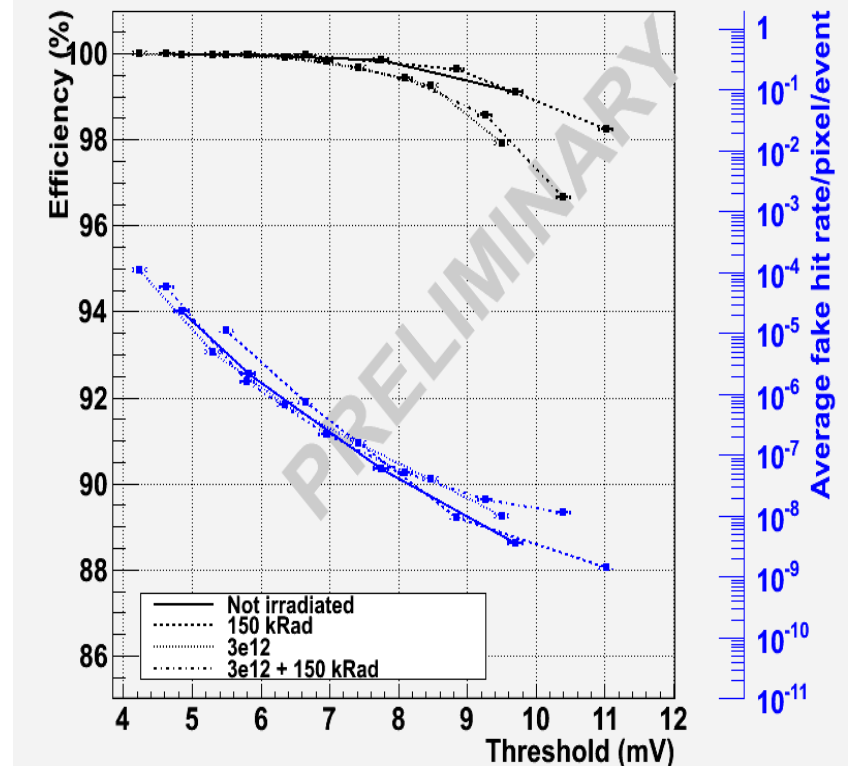


## ▷▷▷ Sensor almost fully evaluated : (50 $\mu m$ thin)

- \*  $N \lesssim 15 e^-$  ENC at 30-35 $^\circ$ C (as MIMOSA-22AHR)
- \* CCE ( $^{55}\text{Fe}$ ) similar to MIMOSA-22AHR
  - o Ionising rad. tolerance validated (150 kRad at 30 $^\circ$ C)
  - o NI rad. tol. validated for  $3 \cdot 10^{12} n_{eq}/\text{cm}^2$  at 30 $^\circ$ C

## ▷▷▷ Start of data taking early 2013

Mimosa 28 - epi 20  $\mu m$  - NC



# FCPPL Project Perspectives

- Problematics addressed :

- Future of BESIII Central Tracker

- ※ BEPC-2 accelerator at IHEP is steadily increasing luminosity
    - ※ Will the beam-related background start deteriorating the detection efficiency of the BESIII central tracker ?



- ▷▷▷ Could pixelated layers make the risk fade away ?

- ※ IHEP-IPHC discussions going on since a few years exploring the question
      - ↳ 4 face-to-face meetings in the last 2 years & 2 seminars at IHEP & IHPC
    - ※ IPHC orienting its CMOS pixel sensor R&D towards large & thin tracker applications
    - ※ IHEP membres (2x2 people/week) testing CMOS pixels at IPHC
      - ↳ CMOS sensor being tested IHEP since  $\sim 1$  year

# The BESIII Experiment

- Installed at BEPC-2  $e^+e^-$  collider:

- ✳  $E_{cm} = 2\text{-}4.6$  GeV (tau-charm factory  $> 10 \times \mathcal{L}_{CESR}$ )
- ✳  $\mathcal{L}_{peak} \sim 10^{33}/\text{cm}^2/\text{s}$  ( $2 \times 1.89$  GeV)
  - $\hookrightarrow 0.65 \cdot 10^{33}/\text{cm}^2/\text{s}$  already achieved
- ✳ horizontal crossing angle =  $\pm 11$  mrad

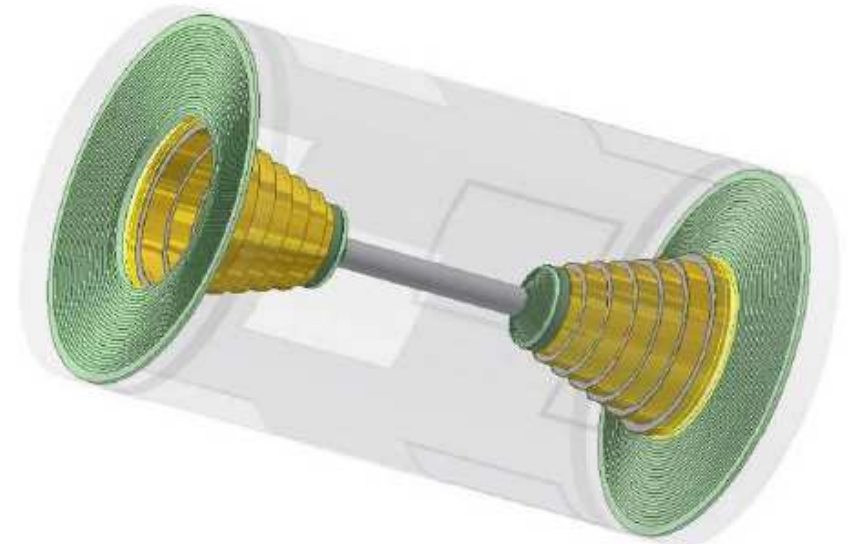
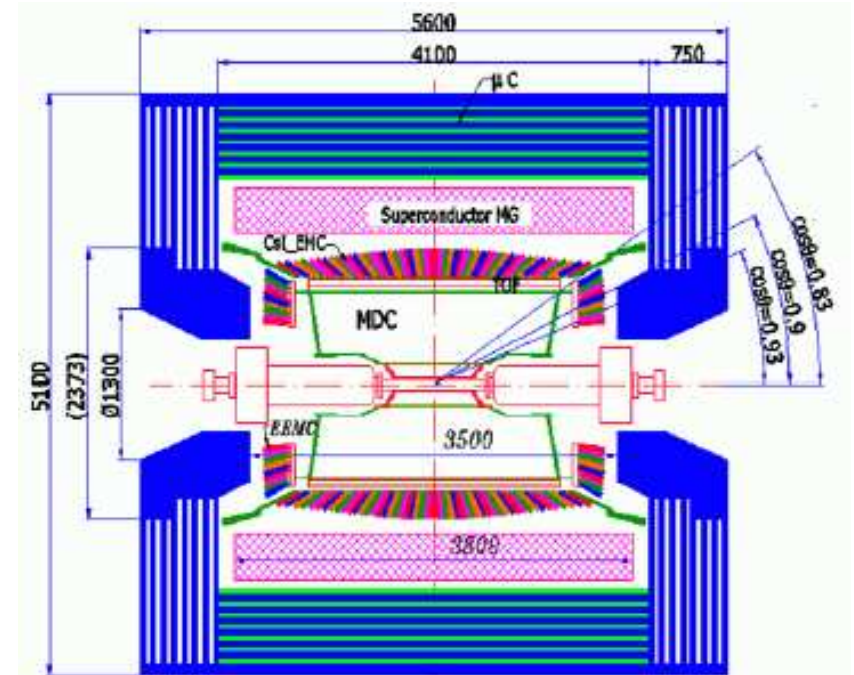
- Central tracker  $\equiv$  (Main) Drift Chamber  $\equiv$  MDC:

- ✳ Radii : 59 – 810 mm
- ✳ Maximal length  $\sim 2.6$  m
- ✳ Conical end-caps to allow moving final focus quads near IP
- ✳ 43 wire layers :  $\sim 22 \cdot 10^3$  field wires &  $7 \cdot 10^3$  sensing wires
- ✳ 1 T experimental solenoidal field

- MDC nominal performances:

- ✳ average momentum in most final states  $\sim 300$  MeV/c
  - $\hookrightarrow \sigma_{R\phi} \lesssim 130 \mu\text{m} \Rightarrow \Delta p/p \simeq 0.5\%$  at 1 GeV/c
- ✳ wire stereo angles ( $-3.4^\circ, +3.9^\circ$ )  $\rightarrow \sigma_Z^{IP} \simeq 2$  mm

Ref: NIM A 614 (2010) pp 345-399



# A Pixelated Upgrade of the MDC

- Goal of the project:

- ✧ 3 innermost wire layers may be saturated at the highest machine luminosity
- ⇒ replace with pixel sensors to cope with beam related background (e.g.  $\gamma_{synch.}$ )
- ✧ total surface to cover  $\sim 1-2 \text{ m}^2$
- ✧ single point resolution is not an issue :  
 $\sigma_{sp} \gtrsim 10 \mu\text{m}$  all right
- ✧ particle rate is not an issue :  
 $t_{int} \sim 100 \mu\text{s}$  all right



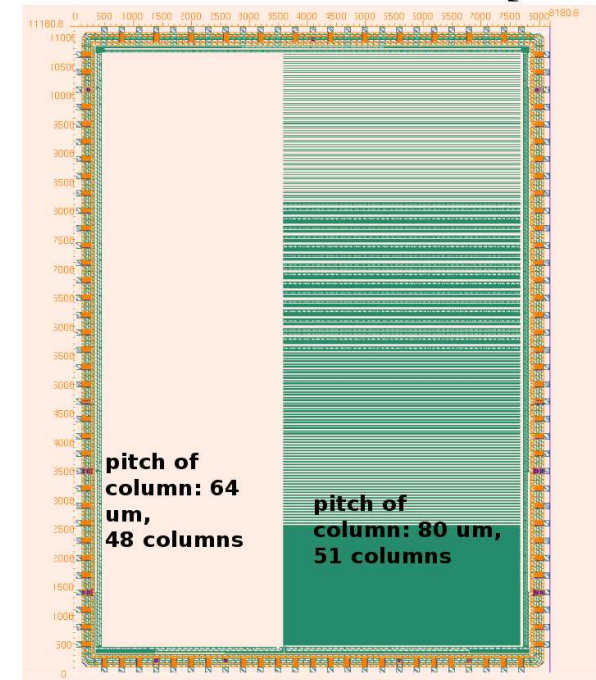
- Adapting CPS to tracker requirements raises 3 challenges:

- ✧ keep  $\sim 100 \%$  detection efficiency with large pixels
- ✧ keep power consumption low enough despite large area ( $> 1 \text{ m}^2$ )
- ✧ keep material budget compatible with  $\Delta p/p \simeq 0.5\%$  at  $1 \text{ GeV}/c$

# Adapting CPS to the MDC Inner Cells

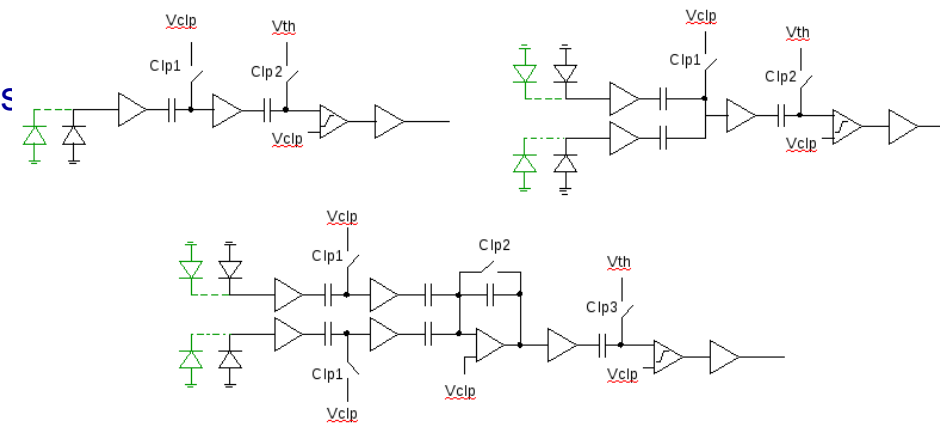
## ● Sensing system :

- ✳ develop sensing system for pixels of  $64 \times 64$  to  $80 \times 80 \mu\text{m}^2$ 
  - ↪ avoid det. efficiency losses for impacts far from sensing diodes
- ✳ optimise the number and the size of the diodes
  - ↪ alleviate "capacitive" noise increase
- ✳ MIMOSA-29:
  - pixels of 16, 32, 48,  $64 \times 64$  & 20, 40,  $80 \times 80 \mu\text{m}^2$
  - 1, 2 or 4 sensing diodes (2 sizes)
  - some amplification variants
  - fabricated in 2011  $\Rightarrow$  tests under way



## ● Next steps: continue improving the low noise pixel design

- ✳ optimise balance between number and noise of sensing diodes
  - ✳ minimise power consumption
  - ✳ watch material budget (i.e. flex cable complexity, cooling, ...)
- $\Rightarrow$  MIMOSA-22THR (0.18  $\mu\text{m}$  process)  
to be fabricated in Q3-2012

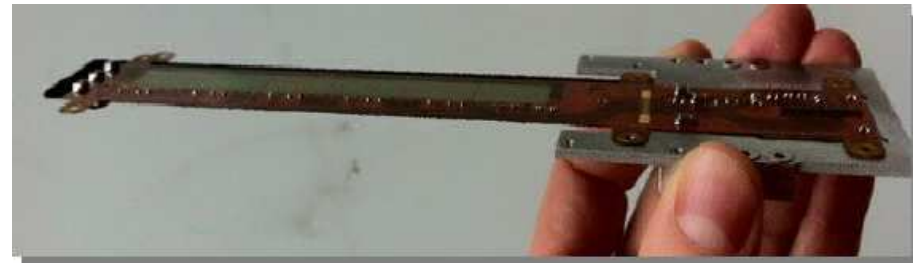
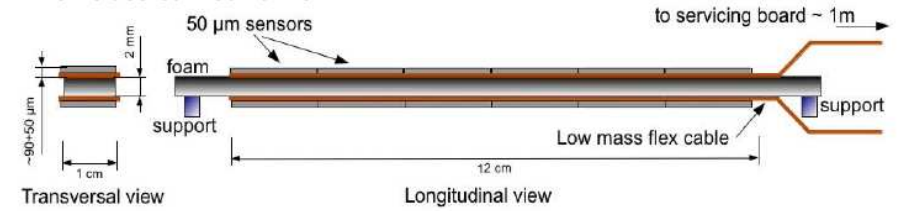




# Ultra-light 2-Sided Ladder

- **50  $\mu\text{m}$  thin sensors mounted on 2-sided ladders:**

- ✧ *PLUME  $\equiv$  Pixelated Ladder with Ultra-Light Material Embedding*
- ✧ *prototype  $\equiv$  6 MIMO-26 mounted on each side of mech. support*
- ✧ *mech. support  $\equiv$  2 mm thick, low density, SiC foam*
- ✧ *total material budget of 2011 proto:  $\sim 0.6\% X_0$*

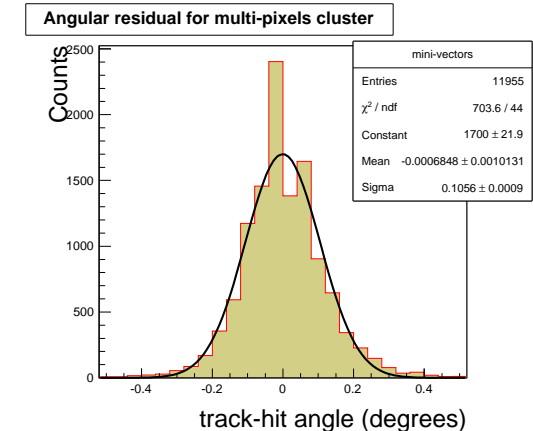
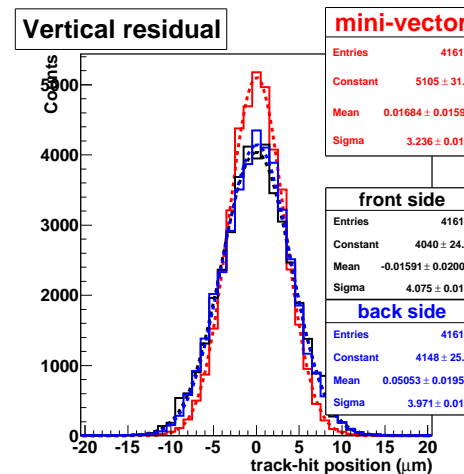


- **PLUME prototype-2010 tested at SPS in Nov. 2011:**

- ✧ *Beam telescope: 2 arms, each made of 2 MIMO-26 sensors*
- ✧ *CERN-SPS beam :  $\gtrsim 100 \text{ GeV } \pi^-$*
- ✧ *BT (track extrapolation) resolution on DUT :  $\sim 1.8 \mu\text{m}$*
- ✧ *PLUME perpendicular & inclined ( $\sim 36^\circ$ ) wrt beam*
- ✧ *Prelim. results on combined impact & pointing resolution*

- **Next steps**

- ✧ *Next PLUME version ( $0.35\% X_0$ ) under construction*
- ✧ *Tests foreseen at CERN-SPS in Dec.'12 or DESY early '13*
- ✧ *Alignment studies based on multi-ladder/layers set-up in 2014/15 (EU project AIDA)*



# SUMMARY

- IHEP-IHPC partnership studies the possibility of enhancing the capability of BESIII to face the highest luminosities achievable at BEPC-2
- Study addresses the possibility of complementing Main Drift Chamber :
  - ✧ with 3 layers of 50  $\mu m$  thin CMOS pixel sensors based on the architecture developed at IPHC
  - ✧ layers may be double-sided, exploiting the concept developed within the PLUME collaboration
- **Next steps :**
  - ✧ IHEP continues exploring added-value of CMOS pixel sensors
  - ✧ IPHC continues prototyping large pitch sensors and ultra-light ladders
  - ✧ Discussions aiming at final evaluation through 2012
- **Partnership benefits from/to global effort towards pixelated large area trackers**
  - ↪ ALICE, ILC, ...